# **IBIS Open Forum Minutes**

Meeting Date: **September 10, 2010**Meeting Location: **Teleconference** 

#### **VOTING MEMBERS AND 2010 PARTICIPANTS**

Agilent Radek Biernacki, Ming Yan, Fangyi Rao, Gilbert Berger,

Amolak Badeasa, Jose Pino, Junaid Khan

AMD Nam Nguyen\*

Ansys (Ansoft Corporation) Danil Kirsanov

Apple Computer (Matt Herndon)

Applied Simulation Technology

ARM (Nirav Patel)

Cadence Design Systems Terry Jernberg\*, Wenliang Dai, Ambrish Varma

Cisco Systems Syed Huq, Mike LaBonte\*, Tony Penaloza, Huyen Pham,

Bill Chen, Ravindra Gali, Zhiping Yang

Ericsson Anders Ekholm\*, Pete Tomaszewski

Freescale Jon Burnett, Om Mandhana

Green Streak Programs Lynne Green Hitachi ULSI Systems Yutaka Uematsu

Huawei Technologies (Jinjun Li)

IBM Adge Hawes, Greg Edlund\*

Infineon Technologies AG Christian Sporrer

Intel Corporation Michael Mirmak\*, Myoung (Joon) Choi, Vishram Pandit,

Richard Mellitz

IO Methodology Lance Wang\* LSI Brian Burdick\*

Mentor Graphics Arpad Muranyi\*, Neil Fernandes, Zhen Mu

Micron Technology Randy Wolff\*
Nokia Siemens Networks GmbH Eckhard Lenski\*
Samtec (Corey Kimble)

Signal Integrity Software Walter Katz\*, Mike Steinberger, Todd Westerhoff,

Barry Katz

Sigrity Brad Brim, Kumar Keshavan, Srdjan Djordjevic,

Ben Franklin

Synopsys Ted Mido, Paul Lo, Geoffrey Ying, Frank Lee

Teraspeed Consulting Group Bob Ross\*, Tom Dagostino

Texas Instruments
Toshiba
Xilinx
Mike Jenkins
ZTE
Bonnie Baker\*
Yoshihiro Hamaji
Mike Jenkins
(Huang Min)

Zuken Michael Schaeder, Ralf Bruening

#### **OTHER PARTICIPANTS IN 2010**

Actel (Prabhu Mohan)
AET, Inc. Mikio Kiyono
Altera John Oh, Hui Fu

Avago Razi Kaw

Bosch Car Multimedia Rene Steinberg, Patric Kessler

Broadcom Mohammad Ali John Phillips Curtiss-Wright ECL, Inc. Tom Iddings eSilicon Hanza Rahmai Exar Corp. Helen Nauven **ICT-Lanto** Steven Wong **JEITA** Atsushi Ishikawa Pietro Vergine Leading Edge

Magna Design Automation Anand Ramalingram

Mindspeed Bobby Altaf National Semiconductor Hsinho Wu

NetLogic Microsystems Eric Hsu, Edward Wu, Antonio Orphanou, Halil Civit

NXP Semiconductors Gerald Krasemann

Politecnico di Torino Igor Stievano, Stefano Grivet-Talocia, Piero Triverio,

Flavio Canavero

Renesas Technology Takuji Komeda

Siemens, AG. Manfred Maurer, Michael Flint

Simberian Yuriy Shlepnev

Span Systems Corporation Vidya (Viddy) Amirapu

Summit Computer Systems Bob Davis
Tabula David Banas
TechAmerica (Chris Denham)
Vitesse Semiconductor Bob McDonough

Independent AbdulRahman (Abbey) Rafiq, Robert Badal

In the list above, attendees at the meeting are indicated by \*. Principal members or other active members who have not attended are in parentheses. Participants who no longer are in the organization are in square brackets.

#### **UPCOMING MEETINGS**

The bridge numbers for future IBIS teleconferences are as follows:

Date Meeting Number Meeting Password

October 1, 2010 209 356 282 IBIS

For teleconference dial-in information, use the password at the following website:

https://cisco.webex.com/cisco/j.php?J=209356282

All teleconference meetings are 8:00 AM to 9:55 AM US Pacific Time. Meeting agendas are typically distributed seven days before each Open Forum. Minutes are typically distributed within seven days of the corresponding meeting. When calling into the meeting, follow the prompts to enter the meeting ID. For new, local international dial-in numbers, please reference the bridge numbers provided by Cisco Systems at the following link:

http://www.cisco.com/web/about/doing\_business/conferencing/index.html

NOTE: "AR" = Action Required.

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#### INTRODUCTIONS AND MEETING QUORUM

No new participants.

## **CALL FOR PATENTS**

Michael Mirmak called for any patents or pending patents related to the IBIS 3.2, IBIS 4.2, IBIS 5.0, Touchstone 2.0 or ICM 1.1 specifications. No patents were declared.

#### **REVIEW OF MINUTES AND ARS**

Randy Wolff called for comments regarding the minutes of the August 20, 2010 IBIS Open Forum teleconference. The minutes were approved without changes.

## **MEMBERSHIP STATUS AND TREASURER'S REPORT**

Michael Mirmak reported that we still have 31 members.

Bob Ross reported that we have a significant surplus of funds for the year due to six parser sales in 2010 as well as one extra member above the budgeted 30 members. The next step is to reconcile the account with TechAmerica. We will need to spend our surplus by the end of the year. Michael noted that we might be able to spend some money on further parser fixes. He is open to ideas for spending the surplus.

#### **WEB PAGE UPDATES**

Michael Mirmak noted changes to the IBIS Interconnect task group page to add minutes and presentations. Links to task groups were updated. The Futures group is now listed as inactive/archived.

Bob Ross recommended moving some links off of the home page to clean it up and create an archives section.

### MAILING LIST ADMINISTRATION

Mike LaBonte reported that he had 5 new subscribers since the last meeting. There are still

issues with server reputation. Some users are still getting emails despite warnings from their email servers. Mike may announce in a future meeting how many emails were sent to the mailing lists so users checking the minutes will be able to cross reference the number of emails they have received.

#### **MODEL LIBRARY UPDATE**

No report.

## **MISCELLANY/ANNOUNCEMENTS**

None.

#### **OPENS FOR NEW ISSUES**

None.

#### INTERNATIONAL/EXTERNAL ACTIVITIES

- DASC

Michael Mirmak noted that there have been no recent meetings and no information relative to IBIS lately. The DASC file and e-mail archive may be found at:

http://www.dasc.org/

- P1735 Encryption

No update. The IEEE Study Group on Encryption web reflector archives are found at:

http://www.eda-stds.org/ip-encrypt/hm/

## -VHDL-AMS Table-Driven Models

Arpad Muranyi reported that the next meeting is on Monday, so he will have a report for the next teleconference. Meetings are once a month on the first Monday of the month.

## -Conferences

The IEEE Conference on Electrical Performance of Electronic Packaging and Systems (EPEPS) is October 24-27, 2010 in Austin, Texas. There are usually topics of interest to IBIS. More information can be found at the following link:

http://epeps.ece.illinois.edu/

-Press Update

None.

## **TECHAMERICA STATUS**

Michael Mirmak reported that TechAmerica is moving to a new physical address in Washington,

D.C. Reponses may be slow in the near term. Michael noted that the ANSI standardization process remains the same. There may be an ANSI audit of TechAmerica in 2011 for review of TechAmerica status. Also, there is an IEC meeting in Seattle in October. We will try to have some attendees at the meeting. There will be some training coming up on TechAmerica's new online standards system beginning September 13 and September 21.

## **IEC APPROVAL ACTIVITIES**

Randy Wolff reported that he re-contacted Stan Krolikoski, the new DASC chair. Stan previously forwarded Randy's email to several people at IEC including Victor Berman. Stan again sent an email to IEC members, but so far there has been no response.

Michael Mirmak suggested Randy ask Dennis Brophy at Mentor for help.

## **SUMMIT STATUS**

## -China Summit Planning

The meeting is at the Four Points by Sheraton hotel in Shenzhen on Tuesday, November 9. Lance Wang and Bob will handle the signups. The deadline to submit presentations is October 12 to allow time to print the booklets. Bob reported that the third announcement went out. We are beginning the signups. Lance is coordinating vendor tables. Lance suggested that the next announcement include clear language noting that the presentations will be reviewed for content. The primary sponsor of the event is Huawei Technologies. Co-sponsors include Agilent Technologies, Ansoft, Cadence Design Systems, Cybernet, Intel, IO Methodology, Mentor Graphics, Signal Integrity Software (SiSoft), Sigrity, Synopsys and ZTE.

#### -Taiwan Summit Planning

The meeting will be held Friday, November 12 at the Sherwood Hotel in Taipei near Intel. Sigrity will assist with the registration. Bob reported that the first announcement has gone out. One presentation has already been submitted. Vendor table are being arranged. A booklet is being planned, so the presentation submittal deadline is October 22. Co-sponsors are Agilent Technologies, Avant Technology (IO Methodology), Foxconn, ICT-Lanto, Intel, Sigrity and Synopsys.

#### -Japan Summit Planning

The meeting will be Monday, November 15 at the JEITA headquarters near Tokyo Station. No lunch is planned. Bob Ross reported that he is planning to send out the first announcement next week. The presentation deadline will be about one week before the meeting. JEITA staff will handle the signups.

## -DesignCon 2011 Planning

EE Times is the new owner. DesignCon is January 31 – February 3, 2011. The Summit is tentatively scheduled for February 3. Contract details are being worked out.

Sponsorship opportunities for all upcoming IBIS summits are available, with sponsors receiving free mentions in the minutes, agenda, and other announcements. Contact the IBIS Board for further details.

#### **IBIS QUALITY TASK GROUP**

Mike LaBonte reported that they are working on a presentation for the upcoming summits including some information on the IEEE Feature Selective Validation. The next meeting is September 21.

The Quality Task Group checklist and other documentation can be found at:

http://www.eda.org/ibis/quality\_wip/

## **IBIS MODEL REVIEW TASK GROUP**

No update.

## ADVANCED TECHNOLOGY MODELING TASK GROUP

Arpad Muranyi reported that the group has finished work on an AMI clarifications BIRD that has been submitted to the Open Forum. They are still working on the AMI flow BIRD and other AMI clarifications BIRDs.

Task group material can be found at:

http://www.eda-stds.org/ibis/macromodel\_wip/

## INTERCONNECT TASK GROUP

Michael Mirmak reported that the group's website has been updated with minutes and presentations. They are currently discussing MCP and IBIS-ISS on alternating weeks. The last meeting covered IBIS-ISS, and there will be a rev 0.6 of the document for the next meeting. A skeleton draft of the MCP proposal is being drafted as well.

Task group material can be found at:

http://www.eda.org/ibis/adhoc/interconnect/

#### **NEW ISSUES**

None.

## BIRD113: WEAK PULL-UP AND WEAK PULL-DOWN RESISTANCE AND VOLTAGE

Greg Edlund circulated an updated version of the BIRD after the last meeting. There have been discussions in the last few weeks on possible additions of a current source. Greg does not plan to make additional changes for this. Michael requested that Greg send him the BIRD113.1 revision for posting and review. This version includes some changes requested in the last Open Forum teleconference.

Bob Ross noted that we still need to discuss the difference between a weak and strong termination. Walter Katz asked Greg to clarify that this BIRD does not change how models simulate and only adds information for checking purposes. Greg confirmed this is the case.

## **BIRD114.1: IBIS-AMI DEFINITION CLARIFICATIONS**

Arpad Muranyi stated that the BIRD clarifies questions brought up by the parser developer. The 114.1 revision made minor changes to some examples to be consistent with the new definition that strings must be surrounded by double quotes. Bob Ross noted that BIRDs clarifying the AMI section are coming in piecemeal, and the whole section may need to be reorganized. He expressed concern about this editing process. Walter Katz added that he tried to propose last year that the whole section be re-written, and it was decided to re-write individual pieces instead. The Open Forum needs to recognize the best way to get a fixed AMI section completed. Walter thinks the real changes have been to the AMI document describing the AMI language and the AMI interface to the DLLs. He proposed that these should be separate documents taken out of the IBIS Specification and allowed to be revised separately and published in a format allowing for graphics. He also said that deprecation issues need to be clarified and addressed. Arpad Muranyi replied that BIRD114.1 and the final outcome of all of these future clarification BIRDs are conveying a technical clarification in the specification, and they are all overlapping. He sees that it is impossible in one BIRD or the other to give the final outcome of the specification language. He felt it was important to address small pieces incrementally in order to make progress. He thinks a careful editing process can be used to rewrite the final AMI section.

Michael Mirmak asked if there was ever an approach discussed to address a few pages at a time. Arpad had not thought about that approach, but he did not think it would work. Walter noted that the organization of the document was not good, as terms are used before they are defined. Arpad added that he is trying to be very careful to keep track of the changes that will be required by adding notes to each of the BIRDs. Bob agreed with the current process, and his expectation is that before any release of an IBIS 5.1 specification, a thorough review of section 6c will be needed. Bob also feels that there should be an editorial committee.

Walter made a specific request noting that there will be several BIRDs coming up from SiSoft, and he wants to write them without constraints of them being in the usual text format. This would be done with the understanding that formatting changes may be made in the future as required for inclusion in IBIS 5.1. The Open Forum will need to decide how to proceed with formatting of the full IBIS specification. Michael added that it would require a BIRD to remove a section from IBIS, but then the removed section could be treated like Touchstone 2.0 or ICM as a separate document.

Bob asked about whether in BIRD114.1 a string can span multiple lines or if only a Description can span multiple lines. Walter noted that the Description definition is detailed so that EDA tools can display a text box with 120 characters of width. This does not exclude carriage return/line feeds in other strings. Anders Ekholm suggested that the BIRD clarify that control characters are allowed within strings.

## **TSCHK2 BUG STATUS**

No BUGs to report. Michael Mirmak noted that the source code is available for purchase.

## **IBISCHK5 BUG STATUS**

Bob Ross introduced BUG121. This BUG noted that a working test for a missing [Component] was corrupted in the IBIS 5.0.0 parser. The BUG was classified as Severe severity, Medium priority and Open status.

#### **IBISCHK5 UPDATE STATUS**

Bob Ross reported that he distributed a first cut of the new parser to a few people for review.

#### **IBIS-ISS STATUS**

Michael Mirmak reported that the document is being updated to Revision 0.6 and discussed in the Interconnect task group meeting. Comments are welcome.

The work in progress document can be found in the following directory:

http://www.eda.org/ibis/ibis-iss\_wip/

#### **NEW ISSUES**

None.

## **NEXT MEETING**

The next IBIS Open Forum teleconference will be held October 1, 2010 from 8:00 to 10:00 AM US Pacific Standard Time.

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#### NOTES

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This meeting was conducted in accordance with the GEIA Legal Guides and GEIA Manual of Organization and Procedure.

The following e-mail addresses are used:

## majordomo@eda.org

In the body, for the IBIS Open Forum Reflector: subscribe ibis <your e-mail address>

In the body, for the IBIS Users' Group Reflector: subscribe ibis-users <your e-mail address>

Help and other commands: help

### ibis-request@eda.org

To join, change, or drop from either or both: IBIS Open Forum Reflector (<a href="mailto:ibis@eda.org">ibis@eda.org</a>) IBIS Users' Group Reflector (<a href="mailto:ibis-users@eda.org">ibis-users@eda.org</a>) State your request.

## ibis-info@eda.org

To obtain general information about IBIS, to ask specific questions for individual response, and to inquire about joining the EIA-IBIS Open Forum as a full Member.

### ibis@eda.org

To send a message to the general IBIS Open Forum Reflector. This is used mostly for IBIS Standardization business and future IBIS technical enhancements. Job posting information is not permitted.

## ibis-users@eda.org

To send a message to the IBIS Users' Group Reflector. This is used mostly for IBIS clarification, current modeling issues, and general user concerns. Job posting information is not permitted.

### ibis-bug@eda.org

To report ibischk parser BUGs as well as tschk2 parser BUGs. The BUG Report Form for ibischk resides along with reported BUGs at:

http://www.eda.org/ibis/bugs/ibischk/ http://www.eda.org/ibis/bugs/ibischk/bugform.txt

The BUG Report Form for tschk2 resides along with reported BUGs at:

http://www.eda.org/ibis/tschk\_bugs/ http://www.eda.org/ibis/tschk\_bugs/bugform.txt

## icm-bug@eda.org

To report icmchk1 parser BUGs. The BUG Report Form resides along with reported BUGs at:

http://www.eda.org/ibis/icm\_bugs/ http://www.eda.org/ibis/icm\_bugs/icm\_bugform.txt

To report s2ibis, s2ibis2 and s2iplt bugs, use the Bug Report Forms which reside at:

http://www.eda.org/ibis/bugs/s2ibis/bugs2i.txt http://www.eda.org/ibis/bugs/s2ibis2/bugs2i2.txt http://www.eda.org/ibis/bugs/s2iplt/bugsplt.txt

Information on IBIS technical contents, IBIS participants and actual IBIS models are available on the IBIS Home page:

http://www.eigroup.org/ibis/ibis.htm

Check the IBIS file directory on eda.org for more information on previous discussions and results:

# http://www.eda.org/ibis/directory.html

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## **IBIS CURRENT MEMBER VOTING STATUS**

## I/O Buffer Information Specification Committee (IBIS)

		Standards Ballot Voting		July 30,	August 20,	September
	Interest					
Organization	Category	Status	July 9, 2010	2010	2010	10, 2010
Advanced Micro Devices	Producer	Active	X	Х	-	Х
Agilent Technologies	User	Active	Χ	Χ	X	-
Ansys	User	Inactive	-	-	-	-
Apple Computer	User	Inactive	-	-	-	-
Applied Simulation Technology	User	Inactive	-	-	-	-
ARM	Producer	Inactive	-	-	-	-
Cadence Design Systems	User	Active	-	X	X	X
Cisco Systems	User	Active	X	X	X	X
Ericsson	Producer	Inactive	X	-	=	X
Freescale	Producer	Inactive	-	-	=	=
Green Streak Programs	General Interest	Inactive	-	-	=	-
Huawei Technologies	Producer	Inactive	-	-	=	-
Hitachi ULSI Systems	Producer	Inactive	-	-	-	-
IBM	Producer	Active	X	X	X	X
Infineon Technologies AG	Producer	Inactive	-	-	=	-
Intel Corp.	Producer	Active	X	X	X	X
IO Methodology	User	Active	X	X	-	X
LSI	Producer	Active	X	X	X	X
Mentor Graphics	User	Active	X	X	X	X
Micron Technology	Producer	Active	X	-	X	X
Nokia Siemens Networks	Producer	Active	X	X	X	X
Samtec	Producer	Inactive	-	-	-	-
Signal Integrity Software	User	Active	X	X	X	X
Sigrity	User	Inactive	-	-	-	-
Synopsys	User	Inactive	-	-	-	-
Teraspeed Consulting	General Interest	Active	X	X	X	X
Texas Instruments	Producer	Inactive	-	-	-	X
Toshiba	Producer	Inactive	-	-	-	-
Xilinx	Producer	Inactive	-	-	-	-
ZTE	User	Inactive	-	-	-	-
Zuken	User	Inactive	-	-	-	-

## CRITERIA FOR MEMBER IN GOOD STANDING:

- Must attend two consecutive meetings to establish voting membership
- MEMBERSHIP DUES CURRENT
- Must not miss two consecutive Meetings

#### INTEREST CATEGORIES ASSOCIATED WITH TECHAMERICA BALLOT VOTING ARE:

- USERS MEMBERS THAT UTILIZE ELECTRONIC EQUIPMENT TO PROVIDE SERVICES TO AN END USER.
- PRODUCERS MEMBERS THAT SUPPLY ELECTRONIC EQUIPMENT.
- GENERAL INTEREST MEMBERS ARE NEITHER PRODUCERS NOR USERS. THIS CATEGORY INCLUDES, BUT IS NOT LIMITED TO,
  GOVERNMENT, REGULATORY AGENCIES (STATE AND FEDERAL), RESEARCHERS, OTHER ORGANIZATIONS AND ASSOCIATIONS,
  AND/OR CONSUMERS.